

CBM-25X-UV Ultraviolet Chip On Board LEDs



Table of Contents

Ordering Information2
Binning Structure3
Typical Device Performance4
Absolute Maximum Ratings4
Optical & Electrical Characteristics
Angular Distribution and Spectrum7
Thermal Resistance8
Mechanical Dimensions 9
Shipping Tray Outline 10
Shipping Label 11
Revision History12

Features:

- Mosaic Array UV LED chipset with 2.5 mm² emitting area, 2.1:1 aspect ratio
- Latest chip technology enables ultra-high power density operation up to 4 A/mm²
- High thermal conductivity isolated copper coreboard package
- Low-profile window for efficient coupling into small-etendue systems
- Environmentally friendly: REACH, RoHS and Halogen compliant

Applications:

- 3D Printing and Additive Manufacturing
- Machine Vision
- Fiber-coupled illumination
- Medical and Scientific Instrumentation



Ordering Information

Ordering Part Numbers

Wayalangth Danga	Radiometric Flux		Wayalangth Pinc	Oudoving Pout Number 12
Wavelength Range	Min. Flux Bin	Min. Flux (W)	Wavelength Bins	Ordering Part Number ^{1,2}
380-390	CA	3.0	380, 385	CBM-25X-UV-Y31-CA380-22
400-410	CA	3.0	400, 405	CBM-25X-UV-Y31-CA400-22

Part Number Nomenclature

CBM	25X		UV		Y31		FFWWW-2#
-----	-----	--	----	--	-----	--	----------

Product Family	Chip Area	Color	Package Configuration	Bin Kit
CBM: Copper-core PCB, Mosiac Array	25X: 2.5 mm²	UV: Ultraviolet	Y31: 26.5 mm x 16 mm See Mechanical Drawing section	See ordering part numbers table below for complete bin definition

Note 1: A Bin Kit represents a group of flux and wavelength bins that are shippable for a given ordering part number. Individual bins are not always orderable, contact Luminus for special requests.

Note 2: Flux Bin listed is minimum bin shipped, higher bins may be included at Luminus' discretion.



Binning Structure

CBM-25X-UV LEDs are specified for flux and peak wavelength at a drive current of 1.0 A with a 20 ms pulse at 25°C and placed into one of the following Power Bins and Wavelength Bins.

Flux Bins

Calar	Color Flow Pin (FF)	Binning @ 1A, 20ms pulse, T _c = 25°C ³		
Color	Flux Bin (FF)	Minimum Flux (W)	Maximum Flux (W)	
	CA	3.0	3.3	
UV	СВ	3.3	3.7	
	CC	3.7	4.0	
	DA	4.0	4.3	
	DB	4.3	4.7	
	DC	4.7	5.0	

Peak Wavelength Bins

Calar	Marcalan ath Din (MANANA)	Binning @ 1A, 20n	ns pulse, T _c = 25°C ³
Color	Wavelength Bin (WWW)	Minimum Wavelength (nm)	Maximum Wavelength (nm)
UV	380	380	385
	385	385	390
	400	400	405
	405	405	410

Note 1: Luminus maintains a +/- 6% tolerance on flux measurements.

Note 2: Products are production tested then sorted and packed by bin.

Note 3: Ratings are based on operation at a constant temperature of $T_c = 25$ °C.



Typical Device Performance ($T_c = 25^{\circ}C$)

General Characteristics		Symbol	Value		Unit
Emitting Area ³		A _e	2.	.5	mm²
Emitting Area Dimensions ³			2.29	· 1.09	mm x mm
Characteristics at Recommended Test Driv	e Curre	ent , I _F 1			
Peak Wavelength Range		λ	380-390	400-410	nm
Peak Wavelength ¹	typ	λ_{p}	385	405	nm
Test Peak Drive Current	typ	I _F	1.0	1.0	А
Radiometric Flux ^{1,2}	typ	Φ_{typ}	3.2	3.1	W
FWHM at 50% of Φv¹	typ	$\Delta\lambda_{_{1/2}}$	15	15	nm
	min	V _{F min}	6.3	6.4	V
Forward Voltage	typ	V _F	7.2	7.4	V
	max	V _{F max}	8.1	8.2	V

Note 1: Unless otherwise noted, values listed are typical. Devices are tested and specified at 1.0 A with a 20 ms pulse at 25°C.

Note 2: Typical radiometric flux is for reference only. Minimum flux values are guaranteed based on the bin kit ordered. For product roadmap and future performance of devices, contact Luminus.

Note 3: Emitting Area and Dimensions is for reference only and subject to change without notice.

Absolute Maximum Ratings

	Symbol	Value	Unit
Absolute Minimum Current (CW or Pulsed) 1	l _{min}	0.2	Α
Absolute Maximum Current (CW) ²	l _{max}	4	А
Absolute Maximum Surge Current ² (Frequency > 240 Hz, duty cycle =10%, t=1ms)	l _s	6	А
Absolute Maximum Junction Temperature ²	T_{jmax}	125	°C
Storage Temperature Range	T _s	-40/+100	°C

Note 1: Special design considerations must be observed for operation under 1.0 A. Please contact Luminus for further information.

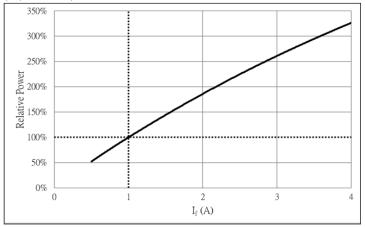
Note 2: CBM-25X-UV LEDs are designed for operation to an absolute maximum current as specified above. Product lifetime data is specified at or below maximum drive current. Sustained operation beyond absolute maximum currents will result in a reduction of device life time. Actual device lifetimes will also depend on junction temperature and operation beyond maximum junction temperature is not recommended. Contact Luminus for lifetime derating curves and for further information. In pulsed operation, rise time from 10-90% of forward current should be longer than 0.5 μ-seconds.



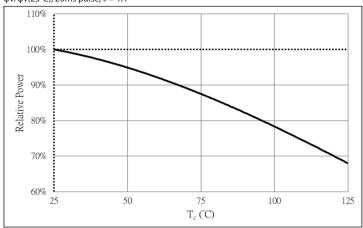
Optical & Electrical Characteristics - 385 nm

Relative Radiometric Flux vs Forward Current

 $\phi v/\phi v(1A)$, 20ms pulse, $T_c = 25^{\circ}C$

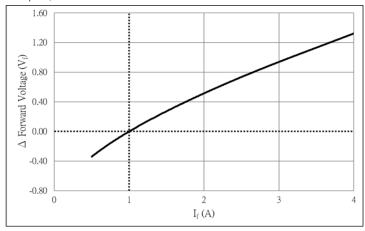


Relative Radiometric Flux vs Temperature $\phi v/\phi v(25^{\circ}C)$, 20ms pulse, $I_r=1A$

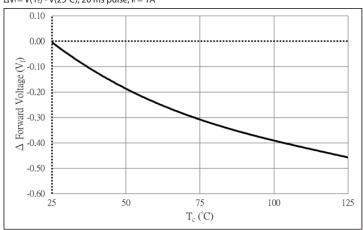


Forward Voltage Shift vs Forward Current

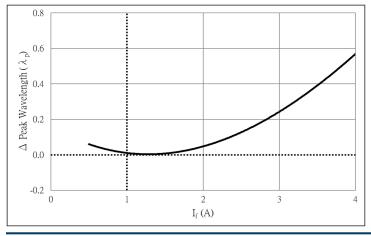
20ms pulse, $T_c = 25^{\circ}C$



Forward Voltage Shift vs Temperature $\Delta V_f = V(T_c) - V(25^{\circ}C)$, 20 ms pulse, $I_f = 1A$

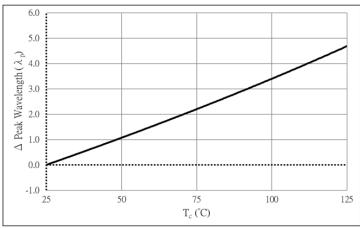


Peak Wavelength Shift vs Forward Current $\Delta\lambda_p = \lambda_p(I_F) - \lambda_p(1A)$, 20ms pulse, $T_c = 25^{\circ}C$



Peak Wavelength Shift vs Temperature

 $\Delta \lambda_p = \lambda_p(T_c) - \lambda_p(25^{\circ}C)$, 20ms pulse, If = 1A

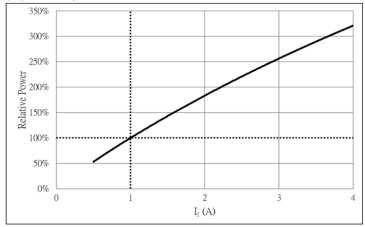




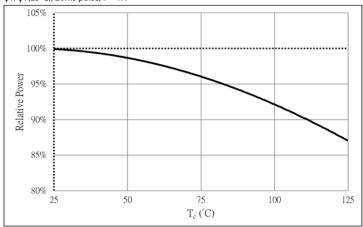
Optical & Electrical Characteristics-405nm

Relative Radiometric Flux vs Forward Current

 $\phi v/\phi v(1A)$, 20ms pulse, $T_c = 25^{\circ}C$

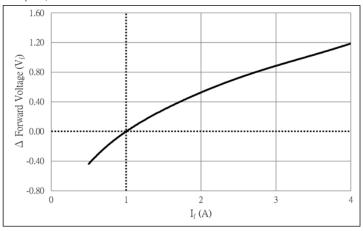


Relative Radiometric Flux vs Temperature $\phi v/\phi v(25^{\circ}C)$, 20ms pulse, $I_r=1A$

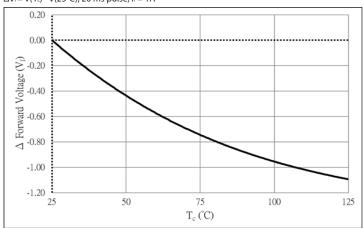


Forward Voltage Shift vs Forward Current

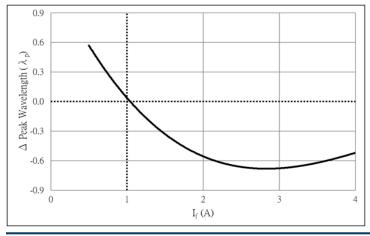
20ms pulse, $T_c = 25^{\circ}C$



Forward Voltage Shift vs Temperature $\Delta V_f = V(T_c) - V(25^{\circ}C)$, 20 ms pulse, $I_f = 1A$

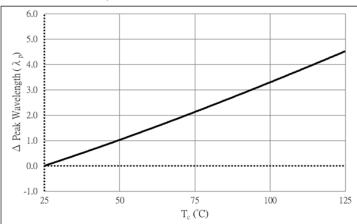


Peak Wavelength Shift vs Forward Current $\Delta\lambda_p = \lambda_p(I_F) - \lambda_p(1A)$, 20ms pulse, $T_c = 25^{\circ}C$



Peak Wavelength Shift vs Temperature

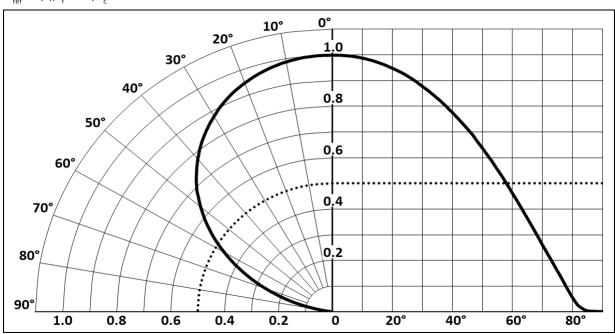
 $\Delta \lambda_p = \lambda_p(T_c) - \lambda_p(25^{\circ}C)$, 20ms pulse, If = 1A





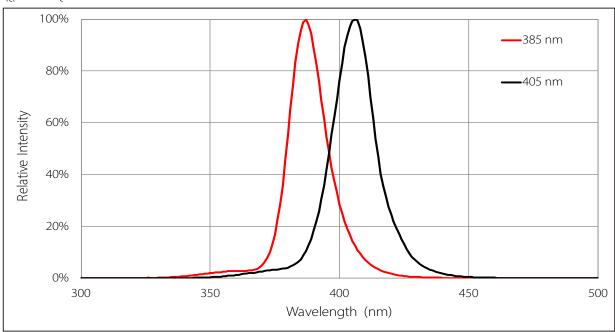
Typical Angular Intensity Distribution¹

$$\Phi_{ref} = f(\lambda); I_f = 1A; T_c = 25^{\circ}C$$



Typical Spectrum²

$$I_{ref} = f(\Phi); T_{c} = 25^{\circ}C$$

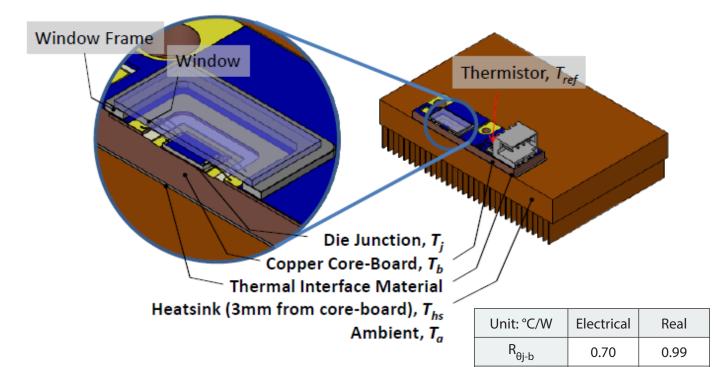


Note 1: Contact Luminus for ray trace files.

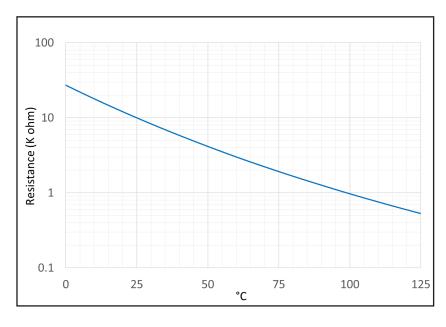
Note 2: Typical spectrum at 1.0 A drive current.



Thermal Resistance



Thermistor Information



The thermistor used in CBM-25X-UV LEDs mounted on core-boards is from Murata Manufacturing Co.
The part number is NCP18XH103J03RB.
Please see http://www.murata.com/ for details on calculating thermistor temperature.

0.89

0.95

 $R_{\theta i\text{-ref}}$

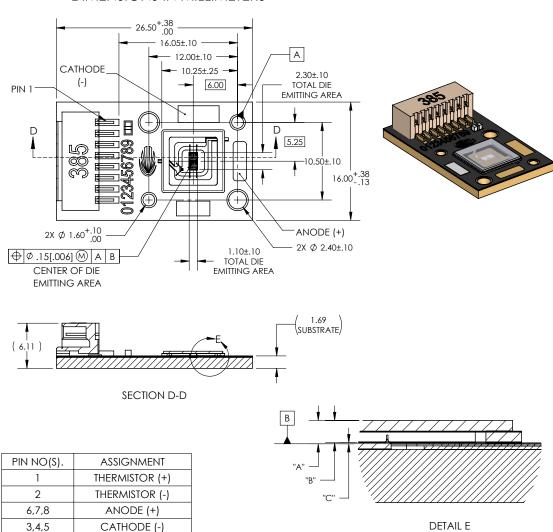
 $For more about calculating thermistor temperature, please see \underline{\text{https://luminusdevices.zendesk.com/hc/en-us/articles/4412023747341-How-do-l-determine-the-temperature-from-Luminus-on-board-Thermistor-board-T$

Important note: The CBM-25X-UV copper PCB is electrically isolated and not active.



Mechanical Dimensions

DIMENSIONS IN MILLIMETERS



DIMENSION NAME	DESCRIPTION	NOMINAL DIMENSION	TOLERANCE
"A"	TOP OF METAL SUBSTRATE TO TOP OF WINDOW	.66	±.11
"B"	TOP OF EMITTING AREA TO TOP OF WINDOW	.63	±.13
"C"	TOP OF METAL SUBSTRATE TO TOP OF EMITTING AREA	.03	±.02

DWG-003119 REVC

Recommended connector harness: Tarng Yu P/N: HTQ001002-210609-01 Check NEC standards for ampacity of the power cable being used

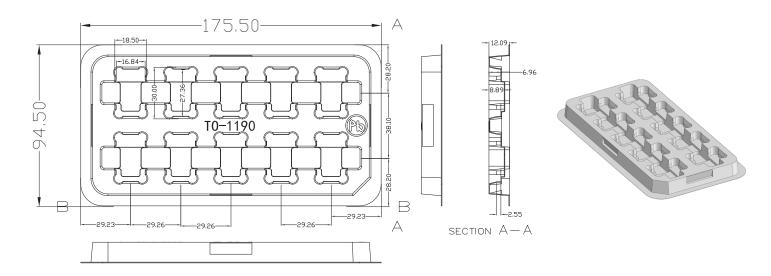
Note 1: The coreboards and windows of LEDs may have minor cosmetic differences, for e.g. slightly different hues, because of different supply sources.

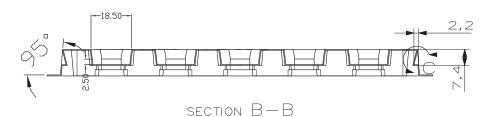
These differences are only cosmetic and do not affect form, fit or function of the LED

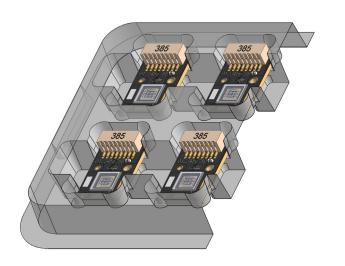
 $Note 2: Back\ of\ the\ coreboard\ is\ electrically\ neutral$

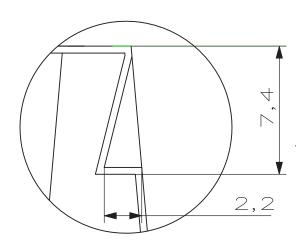


Shipping Tray Outline





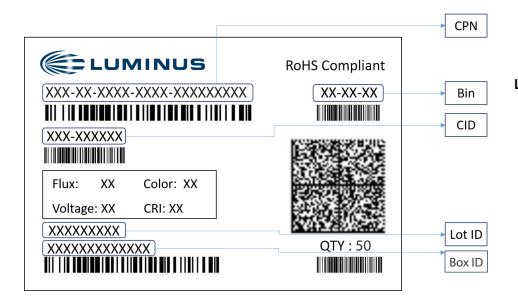




DETAIL C scale 5:1



Shipping Label



Label Fields:

- CPN: Luminus ordering part number
- CID: Customer's part number
- QTY: Quantity of devices in pack
- Flux: Bin as defined on page 3
- Voltage: NA
- Color: Bin as defined on page 3
- CRI: NA

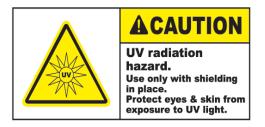
Packing Configuration:

- Maximum stack of 5 trays per pack with 10 devices per tray
- Partial pack or tray may be shipped
- Each pack is enclosed in anti-static bag
- Shipping label is placed on top of each pack



Revision History

Rev	Date	Description of Change
01	03/03/2022	Initial Release
02	05/25/2022	Add shipping information
03	08/05/2022	Extended graphs to 125°C and expanded Rth values
04	10/14/2024	Updated Flux Bins - added DB, DC



The products, their specifications and other information appearing in this document are subject to change by Luminus Devices without notice. Luminus Devices assumes no liability for errors that may appear in this document, and no liability otherwise arising from the application or use of the product or information contained herein. None of the information provided herein should be considered to be a representation of the fitness or suitability of the product for any particular application or as any other form of warranty. Luminus Devices' product warranties are limited to only such warranties as accompany a purchase contract or purchase order for such products. Nothing herein is to be construed as constituting an additional warranty. No information contained in this publication may be considered as a waiver by Luminus Devices of any intellectual property rights that Luminus Devices may have in such information.

This product is protected by U.S. Patents 6,831,302; 7,074,631; 7,083,993; 7,084,434; 7,098,589; 7,105,861; 7,138,666; 7,166,870; 7,166,871; 7,170,100; 7,196,354; 7,211,831; 7,262,550; 7,274,043; 7,301,271; 7,341,880; 7,344,903; 7,345,416; 7,348,603; 7,388,233; 7,391,059 Patents Pending in the U.S. and other countries.